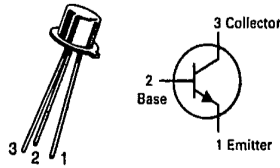


2N2501

**CASE 22-03, STYLE 1
TO-18 (TO-206AA)**



SWITCHING TRANSISTOR

NPN SILICON

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MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V_{CE0}	20	Vdc
Collector-Base Voltage	V_{CB0}	40	Vdc
Emitter-Base Voltage	V_{EB0}	6.0	Vdc
Total Device Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	0.36 2.1	Watt mW/°C
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	1.2 6.9	Watts mW/°C
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-65 to +200	°C

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector-Emitter Breakdown Voltage ($I_C = 30\text{ mAdc}, I_B = 0, \text{ Pulsed}$)	$V_{(BR)CEO}$	20	—	Vdc
Collector-Base Breakdown Voltage ($I_C = 10\text{ }\mu\text{Ade}, I_E = 0$)	$V_{(BR)CBO}$	40	—	Vdc
Emitter-Base Breakdown Voltage ($I_E = 10\text{ }\mu\text{Ade}, I_C = 0$)	$V_{(BR)EBO}$	6.0	—	Vdc
Collector Cutoff Current ($V_{CE} = 20\text{ Vdc}, V_{BE} = 3.0\text{ Vdc}$)	I_{CEX}	—	25	nAde
Base Cutoff Current ($V_{CE} = 20\text{ Vdc}, V_{BE} = 3.0\text{ Vdc}$) ($V_{CE} = 20\text{ Vdc}, V_{BE} = 3.0\text{ Vdc}, T_A = 150^\circ\text{C}$)	I_{BL}	— —	0.025 50	nAde
ON CHARACTERISTICS				
DC Current Gain ($I_C = 100\text{ }\mu\text{Ade}, V_{CE} = 1.0\text{ Vdc}$) ($I_C = 1.0\text{ mAde}, V_{CE} = 1.0\text{ Vdc}$) ($I_C = 10\text{ mAde}, V_{CE} = 1.0\text{ Vdc}$) ($I_C = 10\text{ mAde}, V_{CE} = 1.0\text{ Vdc}, T_A = -55^\circ\text{C}$) ($I_C = 50\text{ mAde}, V_{CE} = 1.0\text{ Vdc}$) ($I_C = 100\text{ mAde}, V_{CE} = 1.0\text{ Vdc}$) ($I_C = 500\text{ mAde}, V_{CE} = 5.0\text{ Vdc}$)	h_{FE}	20 30 50 20 40 30 10	— — 150 — — — —	—
Collector-Emitter Saturation Voltage(1) ($I_C = 10\text{ mAde}, I_B = 1.0\text{ mAde}$) ($I_C = 50\text{ mAde}, I_B = 5.0\text{ mAde}$) ($I_C = 100\text{ mAde}, I_B = 10\text{ mAde}$)	$V_{CE(sat)}$	— — —	0.2 0.3 0.4	Vdc
Base-Emitter Saturation Voltage ($I_C = 10\text{ mAde}, I_B = 1.0\text{ mAde}$) ($I_C = 50\text{ mAde}, I_B = 5.0\text{ mAde}$) ($I_C = 100\text{ mAde}, I_B = 10\text{ mAde}$)	$V_{BE(sat)}$	— — —	0.85 1.0 1.2	Vdc
SMALL-SIGNAL CHARACTERISTICS				
Current-Gain — Bandwidth Product ($V_{CE} = 20\text{ Vdc}, I_C = 10\text{ mAde}, f = 100\text{ MHz}$)	f_T	350	—	MHz
Output Capacitance ($V_{CB} = 10\text{ Vdc}, I_E = 0, f = 100\text{ kHz}$)	C_{obo}	—	4.0	pF
Input Capacitance ($V_{EB} = 0.5\text{ Vdc}, I_C = 0, f = 100\text{ kHz}$)	C_{ibo}	—	7.0	pF
Small-Signal Current Gain ($V_{CE} = 20\text{ Vdc}, I_C = 10\text{ mAde}, f = 100\text{ MHz}$)	h_{fe}	3.5	—	—

ELECTRICAL CHARACTERISTICS (continued) ($T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Max	Unit
SWITCHING CHARACTERISTICS				
Charge Storage Time Constant ($I_C = I_{B1} = I_{B2} = 10 \text{ mAdc}$)	τ_S	—	15	ns
Total Control Charge ($I_C = 10 \text{ mAdc}, I_B = 1.0 \text{ mAdc}$)	Q_T	—	60	pC
Active Region Time Constant ($I_C = 10 \text{ mAdc}$)	τ_A	—	2.5	ns

(1) Pulse Test: Pulse Width $\leq 300 \mu\text{s}$, Duty Cycle $\leq 2.0\%$.

FIGURE 1 — COLLECTOR-EMITTER SATURATION VOLTAGES versus BASE CURRENT

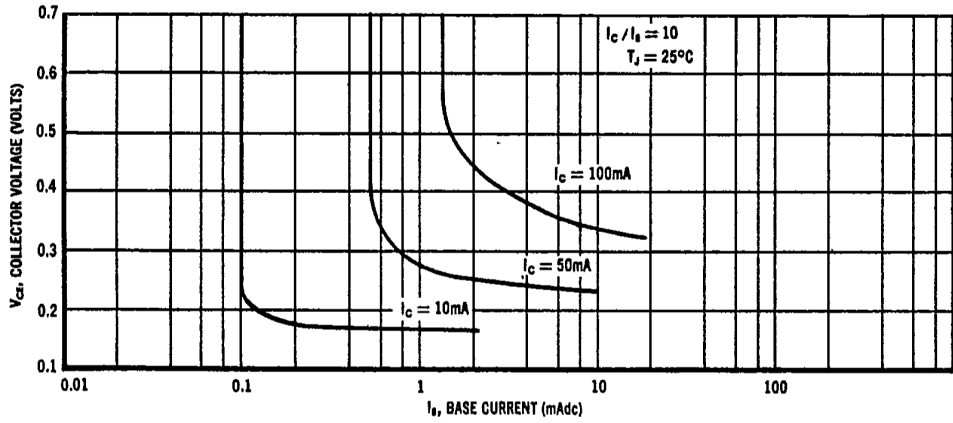


FIGURE 2 — BASE-EMITTER VOLTAGE versus COLLECTOR CURRENT

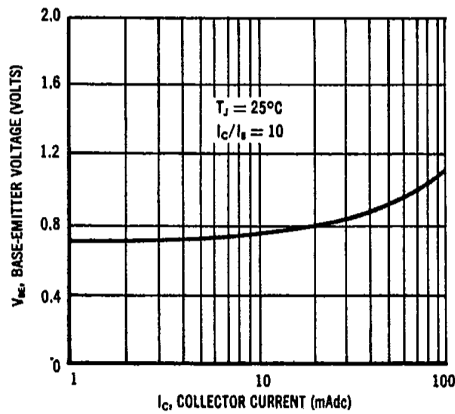
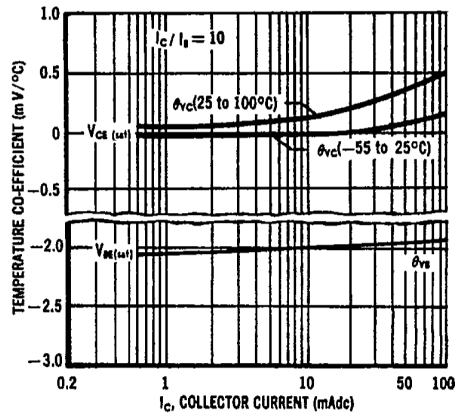


FIGURE 3 — TEMPERATURE COEFFICIENTS



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FIGURE 4 — ACTIVE REGION TIME CONSTANT

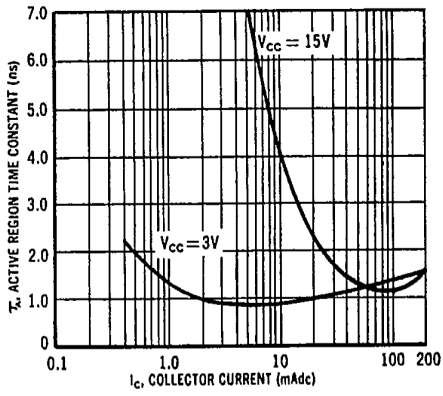
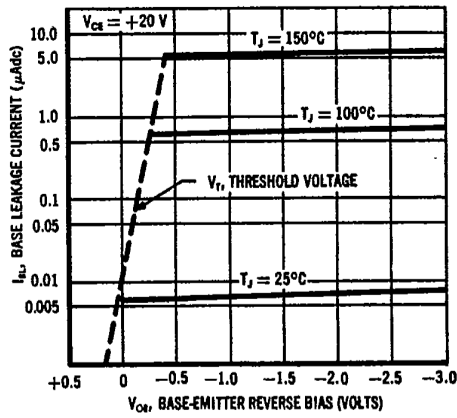


FIGURE 5 — COMMON EMITTER DC LEAKAGE CHARACTERISTICS



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FIGURE 6 — RISE TIME FACTOR

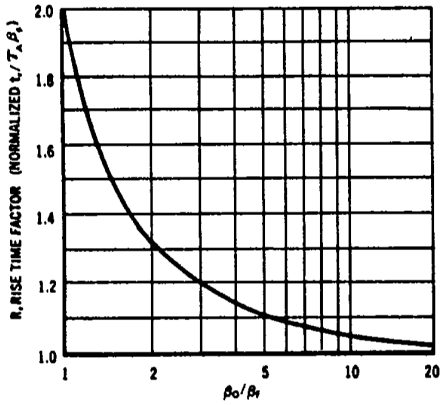


FIGURE 7 — FALL TIME FACTOR

